



B320 - B360

3.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Product Summary

B320/B330/B340			
V _{RRM} (V)	Io (A)	V _F max (V)	I _{R max} (mA)
20/30/40	3.0	0.5	0.5

B350/B360

V _{RRM} (V)	I _O (A)	V _F max (V)	I _{R max} (mA)
50/60	3.0	0.7	0.5

Features and Benefits

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- · Low Power Loss, High Efficiency
- Surge Overload Rating to 125A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- B340Q-13-F Qualified to AEC-Q101 standards for High Reliability

Description and Applications

This Schottky Barrier Rectifier has been designed to meet the general requirements of commercial applications. It is ideally suited fc use as:

- Polarity Protection Diode
- Re-Circulating Diode
- Switching Diode

Mechanical Data

- Case: SMC
- Case Material: Molded Plastic, "Green" Molding compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.21 grams (approximate)

SMC



Top View



Bottom View

Ordering Information (Notes 4 & 5)

Part Number	Compliance	Case	Packaging
B3x0-13-F	Commercial	SMC	3000/Tape & Reel
B340Q-13-F (Note 5)	Automotive	SMC	3000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html
- 5. Other automotive grade 'Q' parts evaluated upon request.

Marking Information (Note 6)



B3x0 = Product type marking code, ex: B320

| | = Manufacturers' code marking

| YWW = Date code marking
| Y = Last digit of year (ex: 13 for 2013)

| WW = Week code (01 to 53)

Note: 6. Device has a cathode band (as shown above) and may also have a cathode notch.



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	B320	B330	B340	B350	B360	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$egin{array}{c} V_{RRM} \ V_{RWM} \ V_{R} \end{array}$	20	30	40	50	60	V
Average Rectified Output Current	Io			3.0			Α
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}			100			А

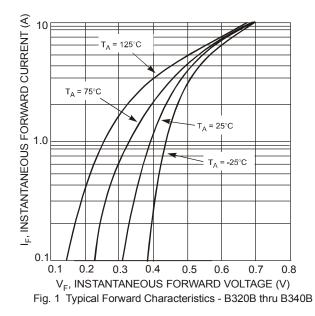
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal	$R_{ heta JT}$	20	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 7)	R _{θJA}	90	°C/W
Operating Temperature Range	T_J	-55 to +150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	B320, B330, B340 B350, B360	\/-			0.50 0.70	٧	I _F = 3.0A, T _A = +25°C
Leakage Current (Note 8)		I _R		_ _	0.5 20		@ Rated V _R , T _A = +25°C @ Rated V _R , T _A = +100°C
Total Capacitance		C _T	1	1	200	pF	V _R = 4V, f = 1MHz

Notes: 7. Thermal Resistance: Junction to terminal, unit mounted on glass epoxy substrate with 2x3mm copper pad 8. Short duration pulse test used to minimize self-heating effect.



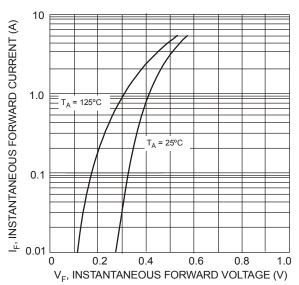
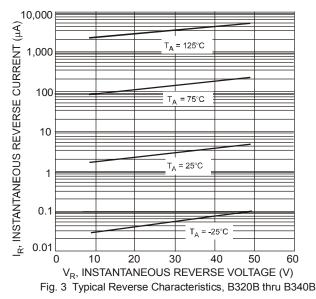
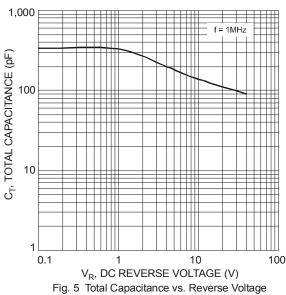


Fig. 2 Typical Forward Characteristics - B350B thru B360B







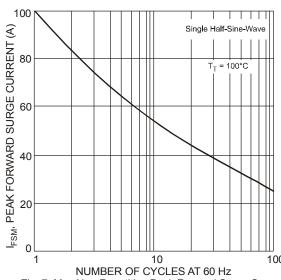
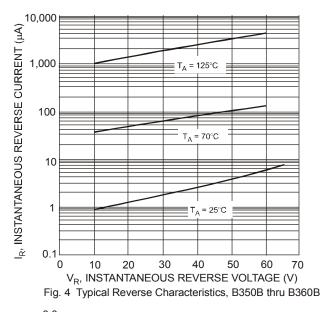
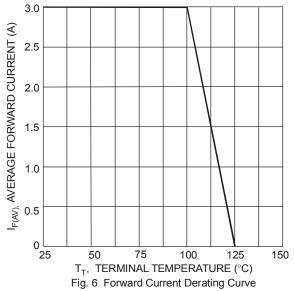


Fig. 7 Max Non-Repetitive Peak Forward Surge Current

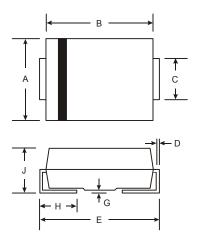






Package Outline Dimensions

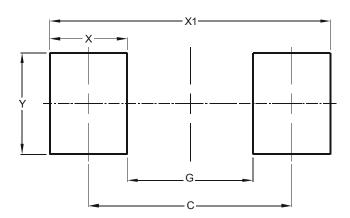
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SMC					
Dim	Min	Max			
Α	5.59	6.22			
В	6.60	7.11			
C	2.75	3.18			
D	0.15	0.31			
Е	7.75	8.13			
G	0.10	0.20			
Н	0.76	1.52			
7	2.00	2.50			
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
С	6.80			
G	4.40			
Х	2.50			
X1	9.40			
Υ	3.30			



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